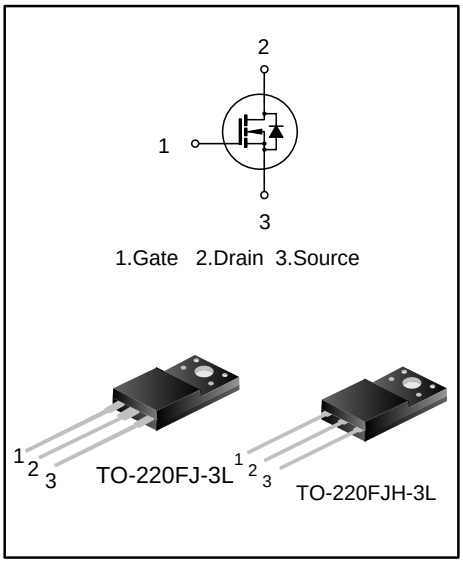
10A, 600V N-CHANNEL MOSFET

GENERAL DESCRIPTION

SVFP10N60CAFJ/FJH is an N-channel enhancement mode power MOS field effect transistor which is produced using Silan proprietary F-Cell™ high-voltage planar VDMOS technology. The improved process and cell structure have been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode.

These devices are widely used in AC-DC power supplies, DC-DC converters and H-bridge PWM motor drivers.



FEATURES

- 10A, 600V, $R_{DS(on)(typ.)}$=0.60Ω@V_{GS}=10V
- Low gate charge
- Low Crss
- Fast switching
- Improved dv/dt capability

ORDERING INFORMATION

Part No.	Package	Marking	Hazardous Substance Control	Packing Type
SVFP10N60CAFJ	TO-220FJ-3L	P10N60CAFJ	Halogen free	Tube
SVFP10N60CAFJH	TO-220FJH-3L	P10N60CA	Halogen free	Tube

ABSOLUTE MAXIMUM RATINGS (T_A=25°C UNLESS OTHERWISE NOTED)

Characteristics		Symbol	Ratings	Unit
Drain-Source Voltage		V_{DS}	600	V
Gate-Source Voltage		V_{GS}	±30	V
Drain Current	T_C = 25°C	I_D	10	A
	T_C = 100°C		6.3	
Drain Current Pulsed		I_{DM}	40	A
Power Dissipation(T_C=25°C)		P_D	45	W
-Derate above 25°C			0.36	W/°C
Single Pulsed Avalanche Energy (Note 1)		E_{AS}	750	mJ
Reverse diode dv/dt (Note 2)		dv/dt	4.5	V/ns
MOSFET dv/dt ruggedness (Note 3)		dv/dt	50	V/ns
Operation Junction Temperature Range		T_J	-55～+150	°C
Storage Temperature Range		T_{stg}	-55～+150	°C

THERMAL CHARACTERISTICS

Characteristics	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	2.78	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	°C/W

ELECTRICAL CHARACTERISTICS (T_J=25°C UNLESS OTHERWISE NOTED)

Characteristics	Symbol	Test conditions		Min.	Typ.	Max.	Unit
Drain -Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V, I_D=250μA		600	--	--	V
Drain-Source Leakage Current	I_{DSS}	V_{DS}=600V, V_{GS}=0V		--	--	1	μA
Gate-Source Leakage Current	I_{GSS}	V_{GS}=±30V, V_{DS}=0V		--	--	±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	V_{GS}= V_{DS}, I_D=250μA		2	--	4	V
Static Drain-Source	$R_{DS(on)}$	V_{GS}=10V,	Tj=25°C	--	0.60	0.75	Ω
On State Resistance		I_D=5.0A	Tj=125°C		1.27		
Gate resistance	R_g	f=1.0MHz		--	4.5	--	Ω
Input Capacitance	C_{iss}	V_{DS}=25V, V_{GS}=0V, f=1.0MHz		--	1300	--	pF
Output Capacitance	C_{oss}			--	150	--	
Reverse Transfer Capacitance	C_{rss}			--	14	--	
Turn-on Delay Time	$t_{d(on)}$	V_{DD}=300V, I_D=10A, R_G=25Ω (Note 4,5)		--	23	--	ns
Turn-on Rise Time	t_r			--	42	--	
Turn-off Delay Time	$t_{d(off)}$			--	67	--	
Turn-off Fall Time	t_f			--	36	--	
Total Gate Charge	Q_g	V_{DS}=480V, I_D=10A, V_{GS}=10V (Note 4,5)		--	34	--	nC
Gate-Source Charge	Q_{gs}			--	7.3	--	
Gate-Drain Charge	Q_{gd}			--	15	--	

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Continuous Source Current	I_S	Integral Reverse P-N Junction	--	--	10	A
Pulsed Source Current	I_{SM}	Diode In The MOSFET	--	--	40	
Diode Forward Voltage	V_{SD}	I_S=10A,V_{GS}=0V	--	--	1.2	V
Reverse Recovery Time	T_{rr}	I_S=10A,V_{GS}=0V,	--	530	--	ns
Reverse Recovery Charge	Q_{rr}	dIF/dt=100A/μs (Note4)	--	4.80	--	μC

Notes:

1. L=30mH, I_{AS}=6.0A, V_{DD}=100V, R_G=25Ω,starting T_J=25°C;
2. V_{DS}=0~400V, I_{SD}<=12A, T_J=25°C;
3. V_{DS}=0~480V;
4. Pulse Test: Pulse width ≤300μs, Duty cycle≤2%;
5. Essentially independent of operating temperature.

TYPICAL CHARACTERISTICS

Figure 1. On-Region Characteristics

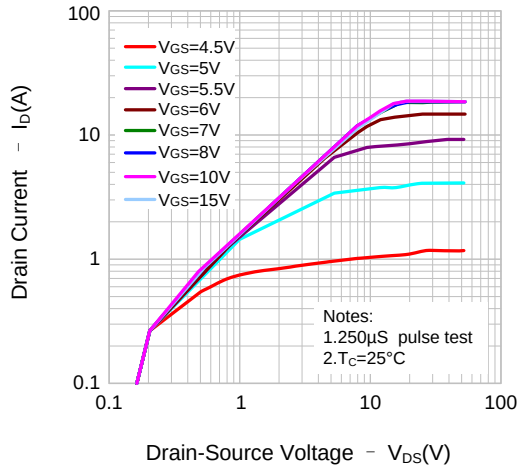


Figure 2. Transfer Characteristics

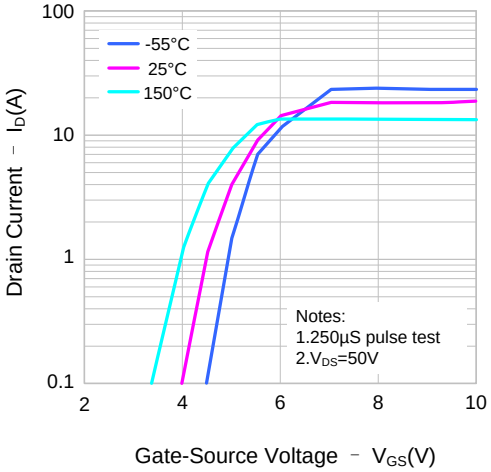


Figure 3. On-Resitance Variation vs. Drain Current and Gate Voltage

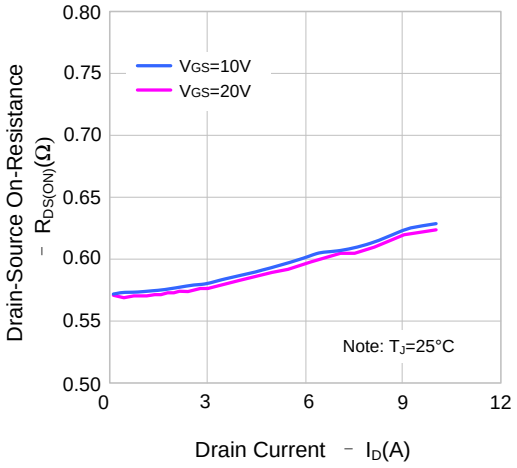


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

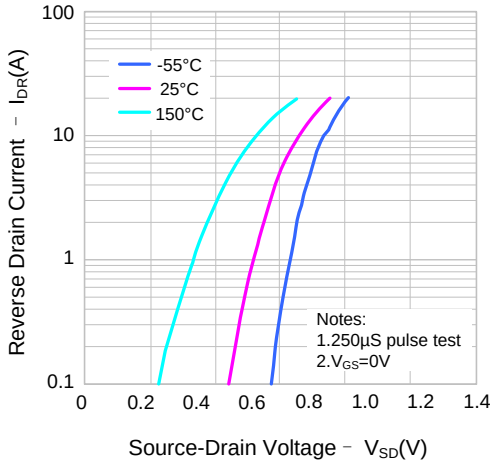


Figure 5. Capacitance Characteristics

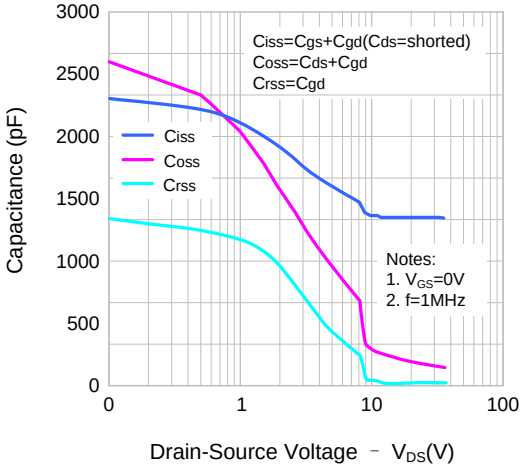
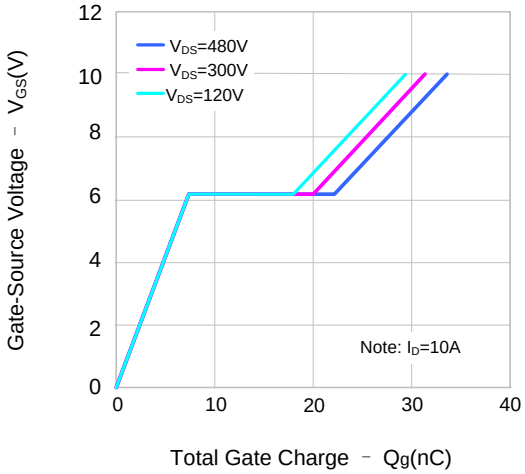


Figure 6. Gate Charge Characteristics



TYPICAL CHARACTERISTICS (CONTINUED)

Figure 7. Breakdown Voltage vs. Temperature

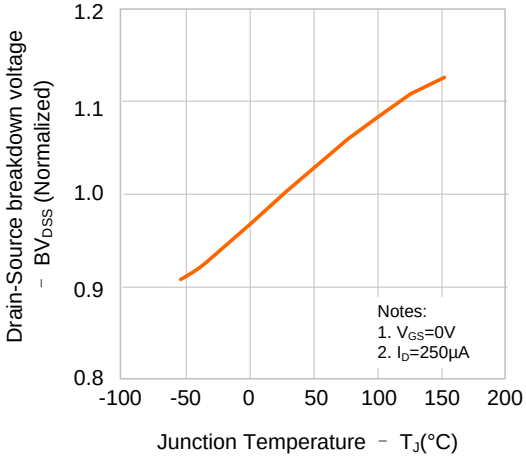


Figure 8. On-resistance Variation vs. Temperature

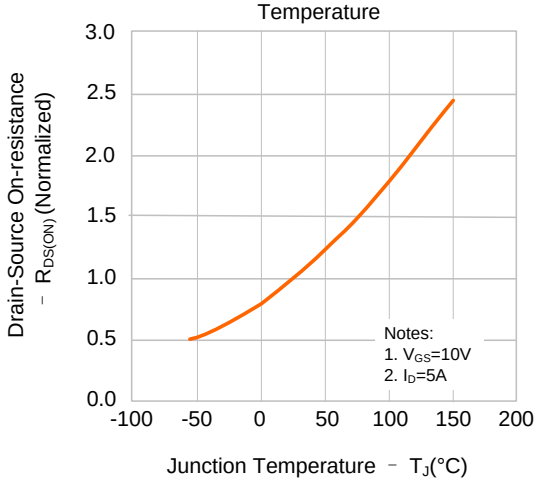


Figure 9. Max. Safe Operating Area

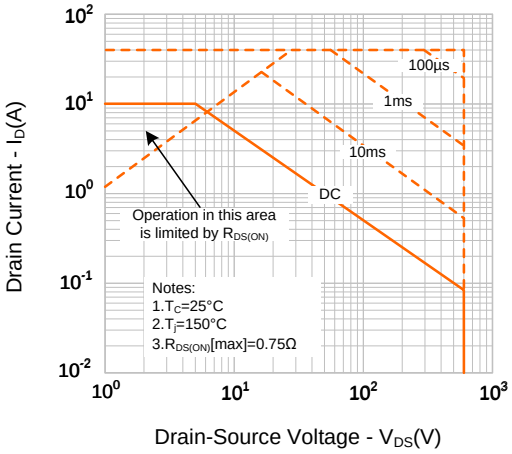
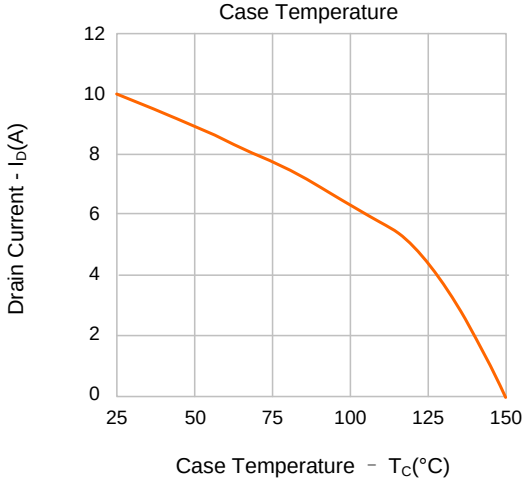
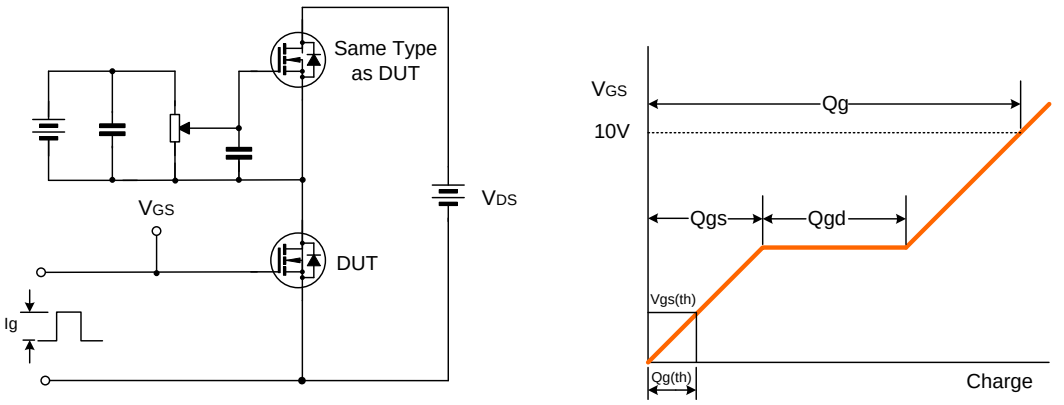


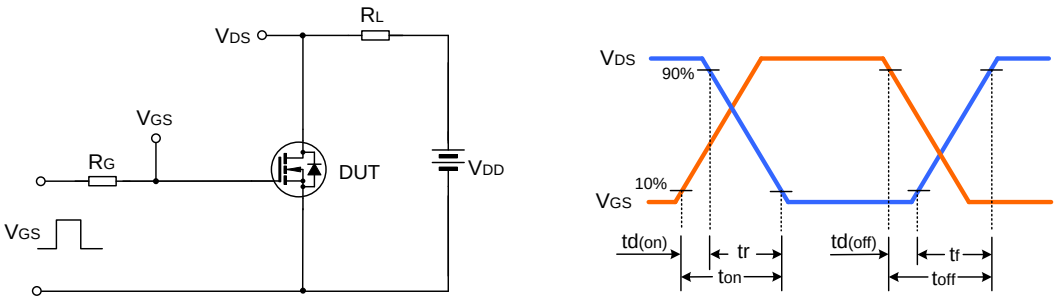
Figure 10. Max. Drain Current vs. Case Temperature



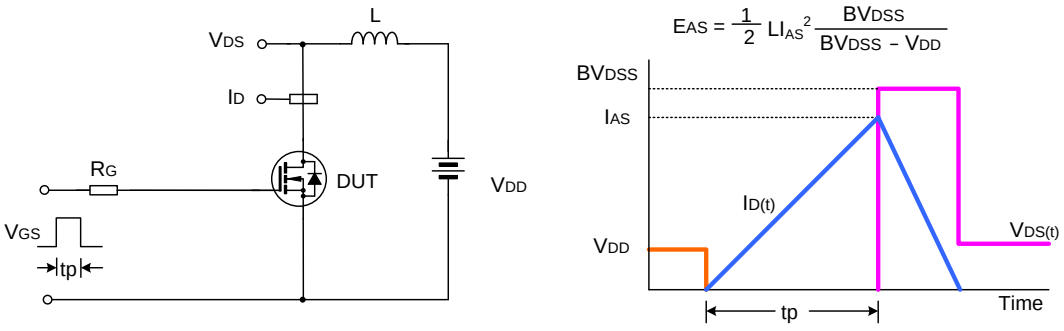
TYPICAL TEST CIRCUIT



Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveform

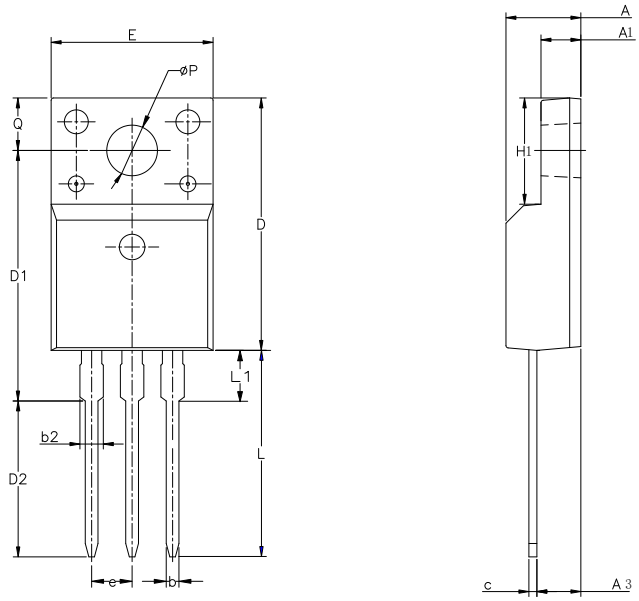


Unclamped Inductive Switching Test Circuit & Waveform

PACKAGE OUTLINE

TO-220FJ-3L

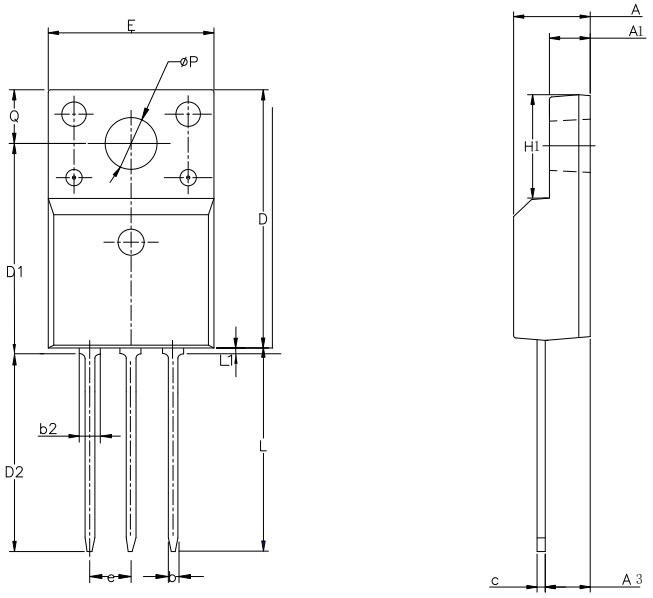
UNIT: mm



SYMBOL	MIN	NOM	MAX
A	4.42	4.70	5.02
A1	2.30	2.54	2.80
A3	2.50	2.76	3.10
b	0.55	0.70	0.85
b2	—	—	1.29
c	0.35	0.50	0.65
D	15.25	15.87	16.25
D1	13.97	14.47	14.97
D2	10.58	11.08	11.58
E	9.73	10.16	10.36
e		2.54BSC	
H1	6.40	6.68	7.00
L	12.48	12.98	13.48
L1	—	—	2.00
øP	3.00	3.18	3.40
Q	3.05	3.30	3.55

TO-220FJH-3L

UNIT: mm



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A1	2.30	2.54	2.80
A3	2.50	2.76	3.10
b	0.55	0.70	**0.80**
b2	—	—	1.29
c	0.35	0.50	0.65
D	15.25	15.87	16.25
D1	12.87	13.07	13.27
D2	12.28	12.48	12.68
E	9.73	10.16	10.36
e		2.54BSC	
H1	6.40	6.68	7.00
L	12.48	12.98	13.48
L1	—	—	0.85
øP	3.00	3.18	3.40
Q	3.05	3.30	3.55

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Rev.: 1.3

Revision History:

1. Motify Electrical schematic and TYPICAL TEST CIRCUIT

Rev.: 1.2

Revision History:

1. Add TO-220FJH-3L

Rev.: 1.1

Revision History:

1. Modify I_{DSS} and V_{SD}

Rev.: 1.0

Revision History:

1. First Release